FAIRCHILE

P-Channel 2.5V PowerTrench[®] MOSFET

General Description

This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

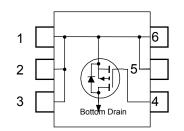
SuperSOT-6[™] FLMP

Applications

- Battery management
- Load Switch
- Battery protection

Features

- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Fast switching speed
- FLMP SuperSOT-6 package: Enhanced thermal performance in industry-standard package size



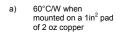
Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain-Sourc	e Voltage		-20	V
V _{GSS}	Gate-Source	e Voltage		±12	V
I _D	Drain Curre	nt – Continuous	(Note 1a)	-7	A
		– Pulsed		-40	
P _D	Power Dissi	pation	(Note 1a)	2	W
			(Note 1b)	1.5	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			–55 to +150	°C
	Thermal Res	eristics sistance, Junction-to-Ambie	nt (Note 1a)	60	°C/W
	1		nt (Note 1a) (Note 1b)	60 111	°C/W
$R_{\theta JA}$	Thermal Res				°C/W
$R_{\theta JA}$ $R_{\theta JC}$	Thermal Res	sistance, Junction-to-Ambie	(Note 1b)	111	°C/W
R _{0JA} R _{0JC} Packag	Thermal Res	sistance, Junction-to-Ambie sistance, Junction-to-Case	(Note 1b)	111	C/W

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to 25°C		-12		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
I _{GSS}	Gate–Body Leakage	$V_{GS} = \pm 12 V$, $V_{DS} = 0 V$			±100	nA
On Char	acteristics (Note 2)	·				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.6	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, I_{D} = -7 \ A \\ V_{GS} = -2.5 \ V, \ I_{D} = -6 \ A \\ V_{GS} = -4.5 \ V, \ I_{D} = -7 \ A, \ T_{J} = 125^{\circ}C \end{array} $		14 21 17	22 30 31	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -7 A$		30		S
•	Characteristics		I		I	
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		2640		pF
Coss	Output Capacitance	f = 1.0 MHz		560		pF
C _{rss}	Reverse Transfer Capacitance			280		pF
R _G	Gate Resistance	V_{GS} = 15 mV, f = 1.0 MHz		3.6		Ω
Switchin	q Characteristics (Note 2)	·				
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -10 V$, $I_D = -1 A$,		16	28	ns
tr	Turn–On Rise Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω		11	19	ns
t _{d(off)}	Turn–Off Delay Time			75	120	ns
t _f	Turn–Off Fall Time			41	65	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -7 A$,		27	38	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -5 V$		5		nC
Q _{gd}	Gate–Drain Charge			7		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				-1.6	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -1.6 A$ (Note 2)		-0.7	-1.2	V
t _{rr}	Reverse Recovery Time	$I_{\rm F} = -7 {\rm A},$		28		ns
Q _{rr}	Reverse Recovery Charge	d _i ⊧/d _t = 100 A/µs		14		nC

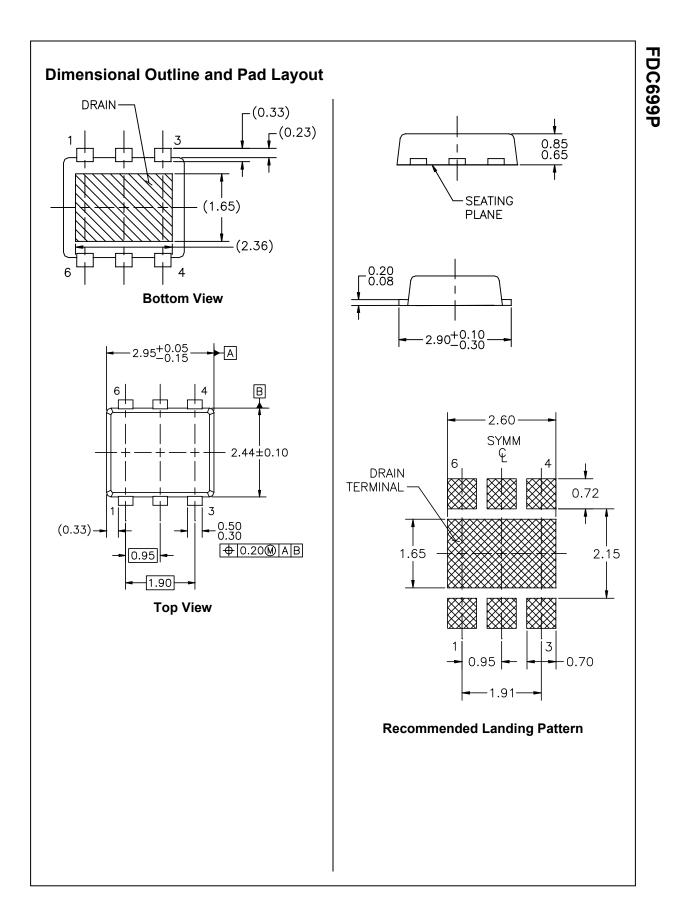


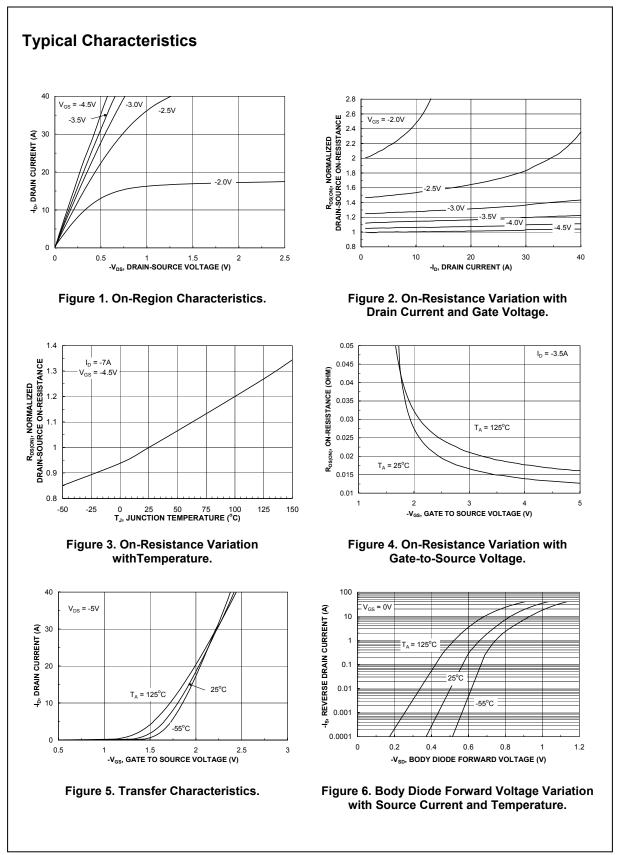


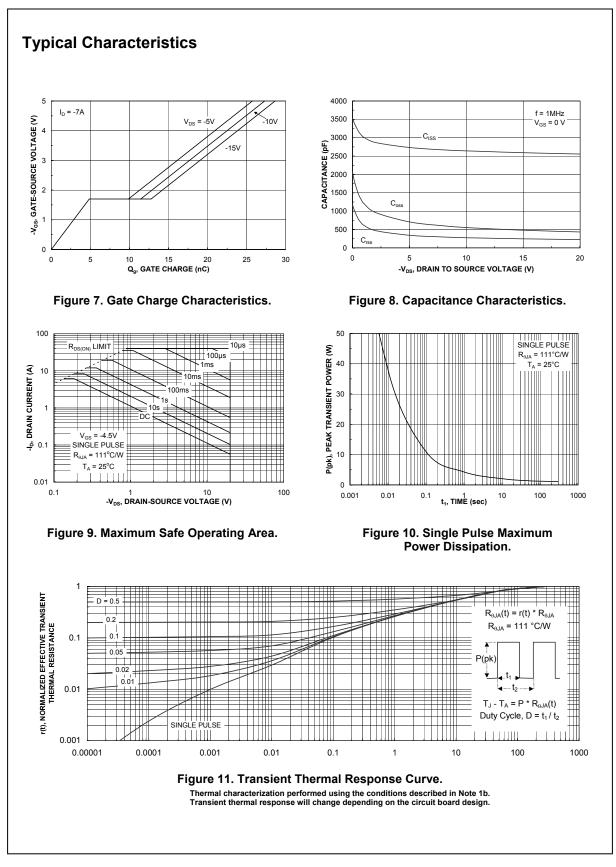


b) 111°C/W when mounted on a minimum pad of 2 oz copper

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%







FDC699P Rev C2 (W)

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CROSSVOLT™	FRFET™	MicroPak™	QS™	SyncFET™
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